



Product Change Notification: CENO-19LKKL699

Date:

23-Sep-2025

Product Category:

Power Management - PMIC, Power Management - PWM Controllers, Switching Regulators

Notification Subject:

CCB 6619 Final Notice: Qualification of UNIG as new assembly site for selected MIC211xx, MIC2225, MIC2285A, MIC23150, MIC232xx, MIC2800, MIC28xx and MIC2821 device families available in various packages.

Affected CPNs:

[CENO-19LKKL699_Affected_CPN_09232025.pdf](#)

[CENO-19LKKL699_Affected_CPN_09232025.csv](#)

PCN Status: Final Notification

PCN Type: Manufacturing Change

Microchip Parts Affected: Please open one of the files found in the Affected CPNs section.

Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change: Qualification of UNIG as new assembly site for selected MIC211xx, MIC2225, MIC2285A, MIC23150, MIC232xx, MIC2800, MIC28xx and MIC2821 device families available in various packages.

Pre and Post Summary Changes:

	Pre Change	Post Change
Assembly Site	Unisem (M) Berhad Perak, Malaysia (UNIS)	Unisem Gopeng (UNIG)
Wire Material	Au	Au
Die Attach Material	8006NS	8006NS

Molding Compound Material	G770HCD	G770HCD
Lead-Frame Material	A194FH	A194FH

Impacts to Datasheet: None

Change Impact: None

Reason for Change: To improve manufacturability by qualifying UNIG as a new assembly site.

Change Implementation Status: In Progress

Estimated First Ship Date: 16 April 2025 (date code: 2516)

Note Below EFSD: Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Timetable Summary:

	November 2023					>	March 2025					April 2025				
	44	45	46	47	48		09	10	11	12	13	14	15	16	17	18
Work Week																
Initial PCN Issue Date				x												
Qual Report Availability								x								
Final PCN Issue Date								x								
Estimated Implementation Date														x		

Method to Identify Change: Traceability Code

Qualification Report: Please open the attachments included with this PCN labeled as PCN_{#}_Qual_Report.

Revision History: November 23, 2023: Issued initial notification.

March 07, 2025: Issued final notification. Attached Qualification Report. Revised affected parts list to remove MIC2111BYMT-T5 and MIC2111CYMT-T5 catalog part numbers due to EOL. Provided

Estimated First Ship Date on April 16, 2025.

September 23, 2025: Re-issued final notification to update the Qualification Report to include wire bond pull, wire bond shear and solderability test results.

Note: The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable product.

Attachments:

[**PCN_CENO-19LKKL699_Qual Report_RevA.pdf**](#)

Please contact your local [**Microchip sales office**](#) with questions or concerns regarding this notification.

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